

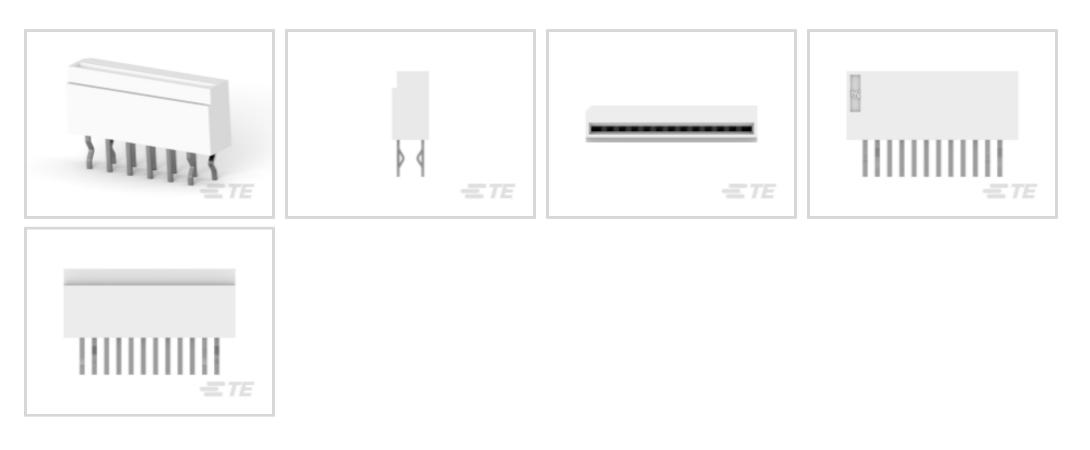
FPC

TE Internal #: 1-84984-2 1 mm [.039 in] Centerline, Non ZIF, Vertical, Through Hole - Solder, Tin, 12 Position, FPC Connectors

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FPC Connectors



Centerline (Pitch): 1 mm [.039 in] Mating Retention Type: Non ZIF PCB Mount Orientation: Vertical Termination Method to PCB: Through Hole - Solder Contact Mating Area Plating Material: Tin

Features

Product Type Features

| PCB Connector Assembly Type | PCB Mount Receptacle | |
|-----------------------------------|--|--|
| Connector Product Type | Connector Assembly | |
| Connector System | Flex-to-Board | |
| Connector & Contact Terminates To | Flexible Printed Circuit (FPC), Printed Circuit Board | |
| Configuration Features | | |
| Compatible With Wire & Cable Type | FFC, FPC | |
| Number of Rows | 1 | |
| PCB Mount Orientation | Vertical | |
| Number of Positions | 12 | |
| Electrical Characteristics | | |
| Operating Voltage | 125 VAC | |
| Body Features | | |
| Primary Product Color | White | |

1 mm [.039 in] Centerline, Non ZIF, Vertical, Through Hole - Solder, Tin, 12 Position, FPC Connectors



Contact Features

| Contact LayoutSContact TypeSContact Mating Area Plating Material ThicknessSPCB Contact Termination Area Plating Material FinishSContact Shape & FormSContact Mating Area Plating Material FinishSPCB Contact Termination Area Plating Material FinishSContact Mating Area Plating Material FinishSPCB Contact Termination Area Plating Material FinishSPCB Contact Termination Area Plating Material FinishSPCB Contact Termination Area Plating MaterialSPCB Contact Termination Area Plating MaterialSPCB Contact Termination Area Plating MaterialSContact Base MaterialSPCB Contact Termination Area Plating MaterialSPCB Contact Base MaterialSPCB Contact Plating Mat | 1 μm[39.37 μin] Staggered Type A Socket 1 μm[39.37 μin] Matte Single Beam Matte Tin | |
|--|--|--|
| Contact TypeSContact Mating Area Plating Material ThicknessSPCB Contact Termination Area Plating Material FinishSContact Shape & FormSContact Mating Area Plating Material FinishSPCB Contact Termination Area Plating Material FinishSPCB Contact Termination Area Plating Material FinishSPCB Contact Termination Area Plating MaterialSPCB Contact Termination Area Plating MaterialSContact Base MaterialSPCB Contact Termination Area Plating MaterialSPCB Contact Base MaterialSPCB Contac | Socket 1 µm[39.37 µin] Matte Single Beam Matte | |
| Contact Mating Area Plating Material Thickness PCB Contact Termination Area Plating Material Finish Contact Shape & Form Contact Mating Area Plating Material Finish PCB Contact Termination Area Plating Material | 1 μm[39.37 μin] Matte Single Beam Matte Tin | |
| PCB Contact Termination Area Plating Material Finish PCB Contact Shape & Form PCD Contact Shape & Form PCD Contact Mating Area Plating Material Finish PCD Contact Termination Area Plating Material PCD Contact Termination Area Plating Material PCD Contact Base Material P | Matte Single Beam Matte Tin | |
| Contact Shape & FormSContact Mating Area Plating Material FinishIPCB Contact Termination Area Plating MaterialSContact Base MaterialI | Single Beam Matte Tin | |
| Contact Mating Area Plating Material Finish I PCB Contact Termination Area Plating Material I Contact Base Material I | Matte Tin | |
| PCB Contact Termination Area Plating Material Contact Base Material | Tin | |
| Contact Base Material | | |
| | Phosphor Bronze | |
| Contact Current Rating (Max) | | |
| | 1 A | |
| Contact Mating Area Plating Material | Tin | |
| Termination Features | | |
| Termination Post & Tail Length | 3 mm[.118 in] | |
| Termination Method to PCB | Through Hole - Solder | |
| Mechanical Attachment | | |
| Mating Alignment | With | |
| PCB Mount Alignment | With | |
| PCB Mount Retention | With | |
| PCB Mount Retention Type | Kinked Solder Tails | |
| Connector Mounting Type | Board Mount | |
| Mating Retention Type | Non ZIF | |
| Housing Features | | |
| Housing Material | PBT GF | |
| Centerline (Pitch) | 1 mm[.039 in] | |
| Dimensions | | |
| Connector Length | 14 mm[.551 in] | |
| Accepts Flex Cable Thickness | .3 mm[.012 in] | |
| Connector Height | 5.6 mm[.22 in] | |
| Connector Width | 3 mm[.118 in] | |
| PCB Thickness (Recommended) | 1.6 mm[.063 in] | |

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| Operating Temperature Range | -20 – 85 °C[-4 – 185 °F] |
|---|--------------------------|
| Operation/Application | |
| Circuit Application | Signal |
| Identification Marking | |
| Circuit Identification Feature | With |
| Packaging Features | |
| Packaging Quantity | 34 |
| Packaging Method | |
| | Box & Tube, Tube |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU | Compliant |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU | Compliant |

Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

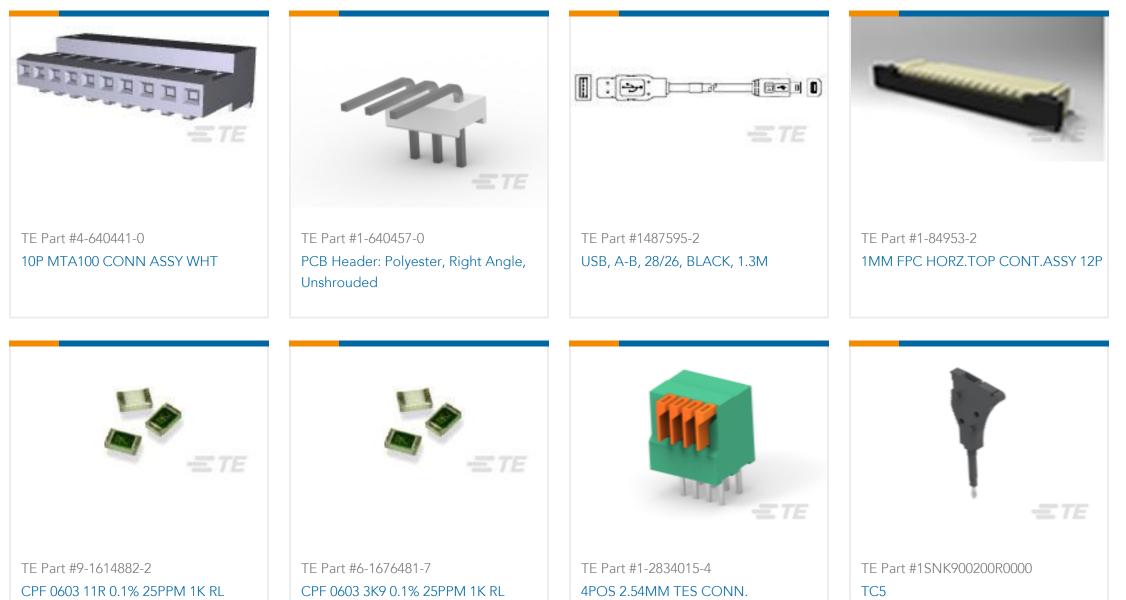
Compatible Parts

1 mm [.039 in] Centerline, Non ZIF, Vertical, Through Hole - Solder, Tin, 12 Position, **FPC** Connectors





Customers Also Bought



| CPF 0603 | 11R U.1% Z5P | PIVI I K KL |
|----------|--------------|-------------|
|----------|--------------|-------------|

Documents

Product Drawings

1mm FFC DIP V ASSY 12P TUBE

English

CAD Files

Customer View Model ENG_CVM_CVM_1-84984-2_D.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-84984-2_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-84984-2_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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Datasheets & Catalog Pages

FPC Connector Family

English

1-1773959-7-FPC-Connectors-CN

English

Product Specifications

Product Specification

English